





Features:

- Low Power Programmable Oscillator
- Any frequency between 1 MHz and 110 MHz accurate to 6 decimal places
- 100% pin-to-pin drop-in replacement to quartz-based XO
- Operating temperature from -40°C to 85°C.
- Low power consumption of 3.5 mA typical at 1.8V
- Standby mode for longer battery life, fast startup time of 5 ms
- LVCMOS/HCMOS compatible output
- Industry-standard packages: 2.0 x 1.6, 2.5 x 2.0, 3.2 x 2.5, 5.0 x 3.2, 7.0 x 5.0 mm x mm

Applications:

- Ideal for DSC, DVC, DVR, IP CAM, Tablets, e-Books, SSD, GPON, EPON, etc
- Ideal for high-speed serial protocols such as: USB, SATA, SAS, Firewire, 100M / 1G / 10G Ethernet, etc.

Electrical Specifications

Table 1. Electrical Characteristics

All Min and Max limits are specified over temperature and rated operating voltage with 15 pF output load unless otherwise stated. Typical values are at 25°C and nominal supply voltage.

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition
			F	requency R	ange	
Output Frequency Range	f	1	-	110	MHz	
	•		Freque	ncy Stability	and Aging	j
Frequency Stability	F_stab	-20	-	+20	ppm	Inclusive of initial tolerance at 25°C, 1st year aging at 25°C, and
		-25	-	+25	ppm	variations over operating temperature, rated power supply voltage and load.
		-50	-	+50	ppm	
	•		Operati	ng Tempera	ture Range)
Operating Temperature Range	T_use	-20	-	+70	°C	Extended Commercial
		-40	-	+85	°C	Industrial
		S	upply Voltag	ge and Curr	ent Consur	nption
Supply Voltage	Vdd	1.62	1.8	1.98	V	
		2.25	2.5	2.75	V	
		2.52	2.8	3.08	V	
		2.7	3.0	3.3	V	
		2.97	3.3	3.63	V	
		2.25	-	3.63	V	
Current Consumption	ldd	-	3.8	4.5	mA	No load condition, f = 20 MHz, Vdd = 2.8V to 3.3V
		-	3.7	4.2	mA	No load condition, f = 20 MHz, Vdd = 2.5V
		-	3.5	4.1	mA	No load condition, f = 20 MHz, Vdd = 1.8V
OE Disable Current	I_OD	-	-	4.2	mA	Vdd = 2.5V to 3.3V, OE = GND, Output in high-Z state
		-	-	4.0	mA	Vdd = 1.8V, OE = GND, Output in high-Z state
Standby Current	I_std	-	2.1	4.3	μΑ	ST = GND, Vdd = 2.8V to 3.3V, Output is weakly pulled down
		-	1.1	2.5	μA	ST = GND, Vdd = 2.5V, Output is weakly pulled down
		-	0.2	1.3	μΑ	ST = GND, Vdd = 1.8V, Output is weakly pulled down
			LVCMOS	Output Ch	aracteristic	SS
Duty Cycle	DC	45	-	55	%	All Vdds. See Duty Cycle definition in Figure 3 and Footnote 8
Rise/Fall Time	Tr, Tf	-	1	2	ns	Vdd = 2.5V, 2.8V, 3.0V or 3.3V, 20% - 80%
		-	1.3	2.5	ns	Vdd =1.8V, 20% - 80%
		-	-	2	ns	Vdd = 2.25V - 3.63V, 20% - 80%
Output High Voltage	VOH	90%	-	-	Vdd	IOH = -4 mA (Vdd = 3.0V or 3.3V) IOH = -3 mA (Vdd = 2.8V and Vdd = 2.5V) IOH = -2 mA (Vdd = 1.8V)
Output Low Voltage	VOL	-	-	10%	Vdd	IOL = 4 mA (Vdd = 3.0V or 3.3V) IOL = 3 mA (Vdd = 2.8V and Vdd = 2.5V) IOL = 2 mA (Vdd = 1.8V)

come visit our site http://www.vxc.hk

 \oplus 1/9



YSO8008MR



Table 1. Electrical Characteristics (continued)

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition
			Inp	ut Characte	eristics	
Input High Voltage	VIH	70%	-	-	Vdd	Pin 1, OE or ST
Input Low Voltage	VIL	-	-	30%	Vdd	Pin 1, OE or ST
Input Pull-up Impedance	Z_in	50	87	150	kΩ	Pin 1, OE logic high or logic low, or ST logic high
		2	-	-	MΩ	Pin 1, ST logic low
			Startu	o and Resu	me Timing	
Startup Time	T_start	-	-	5	ms	Measured from the time Vdd reaches its rated minimum value
Enable/Disable Time	T_oe	-	-	130	ns	f = 110 MHz. For other frequencies, T_oe = 100 ns + 3 * cycles
Resume Time	T_resume	-	-	5	ms	Measured from the time ST pin crosses 50% threshold
				Jitter		·
RMS Period Jitter	T_jitt	-	1.8	3	ps	f = 75 MHz, Vdd = 2.5V, 2.8V, 3.0V or 3.3V
		-	1.8	3	ps	f = 75 MHz, Vdd = 1.8V
Peak-to-peak Period Jitter	T_pk	-	12	25	ps	f = 75 MHz, Vdd = 2.5V, 2.8V, 3.0V or 3.3V
		_	14	30	ps	f = 75 MHz, Vdd = 1.8V
RMS Phase Jitter (random)	T_phj	-	0.5	0.9	ps	f = 75 MHz, Integration bandwidth = 900 kHz to 7.5 MHz
		-	1.3	2	ps	f = 75 MHz, Integration bandwidth = 12 kHz to 20 MHz

Table 2. Pin Description

Pin	Symbol		Functionality						
		Output Enable	H ^[1] : specified frequency output L: output is high impedance. Only output driver is disabled.						
1	OE/ ST/NC	Standby	H ^[1] : specified frequency output L: output is low (weak pull down). Device goes to sleep mode. Supply current reduces to I_std.						
		No Connect	Any voltage between 0 and Vdd or Open ^[1] : Specified frequency output. Pin 1 has no function.						
2	GND	Power	Electrical ground						
3	OUT	Output	Oscillator output						
4	VDD	Power	Power supply voltage ^[2]						

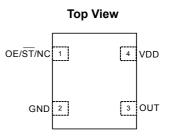


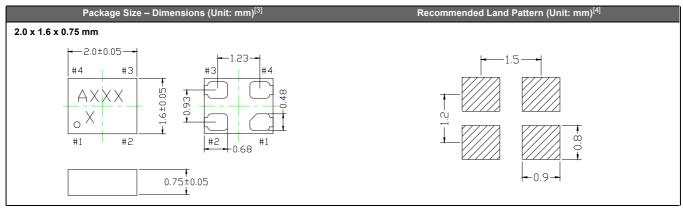
Figure 1. Pin Assignments

Notes:

In OE or ST mode, a pull-up resistor of 10 kΩ or less is recommended if pin 1 is not externally driven. If pin 1 needs to be left floating, use the NC option.

2. A capacitor of value 0.1 μF or higher between Vdd and GND is required.

Dimensions and Patterns

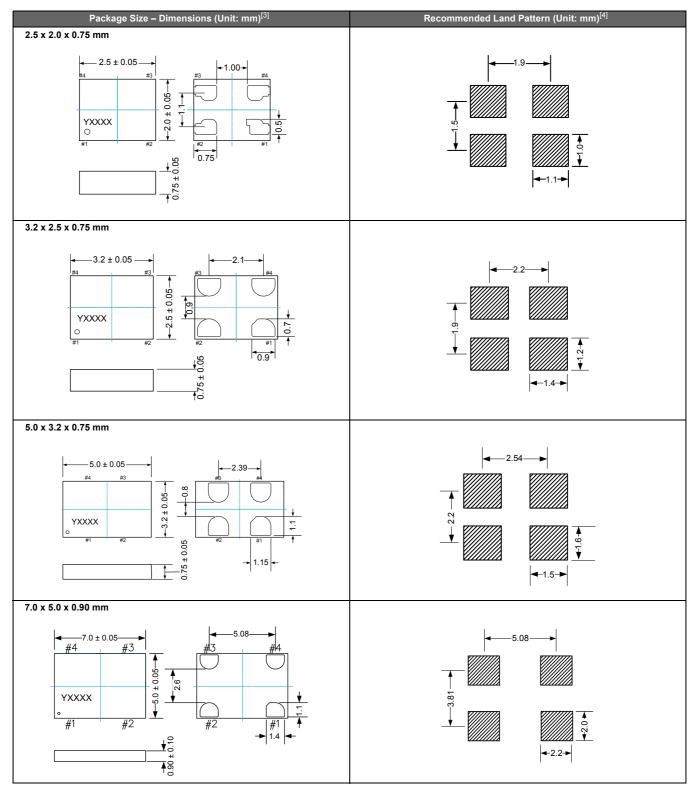


⊕<u>_</u>/9





Dimensions and Patterns



Notes:

3. Top marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.

4. A capacitor of value 0.1 μ F or higher between Vdd and GND is required.

PART Number Guide

Quartz Crystal Oscillator	Dimensions	Frequency (Hz)	Supply voltage (V)	Frequency Stability Overall (ppm)	Output	Pin	Material	Operating Temp. Range
0	7050	100M	Е	Е	Н	4	М	Ι







Table 3. Absolute Maximum Limits

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Min.	Max.	Unit
Storage Temperature	-65	150	°C
Vdd	-0.5	4	V
Electrostatic Discharge	-	2000	V
Soldering Temperature (follow standard Pb free soldering guidelines)	-	260	°C
Junction Temperature ^[5]	-	150	°C

Note:

5. Exceeding this temperature for extended period of time may damage the device.

Table 4. Thermal Consideration^[6]

Package	θJA, 4 Layer Board (°C/W)	θJA, 2 Layer Board (°C/W)	θJC, Bottom (°C/W)
7050	142	273	30
5032	97	199	24
3225	109	212	27
2520	117	222	26
2016	152	252	36

Note:

6. Refer to JESD51 for 0JA and 0JC definitions, and reference layout used to determine the 0JA and 0JC values in the above table.

Table 5. Maximum Operating Junction Temperature^[7]

Max Operating Temperature (ambient)	Maximum Operating Junction Temperature
70°C	80°C
85°C	95°C

Note:

7. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

Table 6. Environmental Compliance

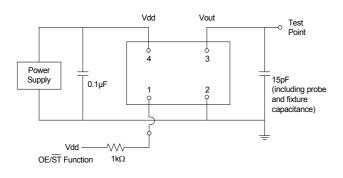
Parameter	Condition/Test Method				
Mechanical Shock	MIL-STD-883F, Method 2002				
Mechanical Vibration	MIL-STD-883F, Method 2007				
Temperature Cycle	JESD22, Method A104				
Solderability	MIL-STD-883F, Method 2003				
Moisture Sensitivity Level	MSL1 @ 260°C				

4/9

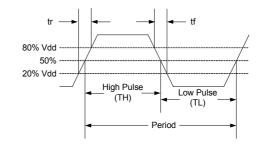




Test Circuit and Waveform^[8]





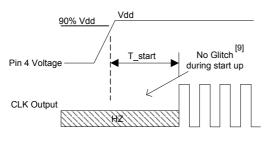




Note:

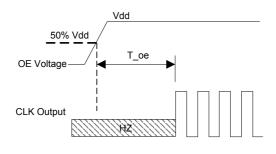
8. Duty Cycle is computed as Duty Cycle = TH/Period.

Timing Diagrams



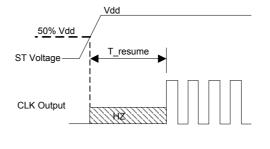
T_start: Time to start from power-off





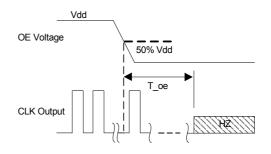
T_oe: Time to re-enable the clock output

Figure 6. OE Enable Timing (OE Mode Only)



T_resume: Time to resume from ST

Figure 5. Standby Resume Timing (ST Mode Only)



T_oe: Time to put the output in High Z mode

Figure 7. OE Disable Timing (OE Mode Only)

Note:

9. YSO8008MR has "no runt" pulses and "no glitch" output during startup or resume.

÷ 5/9





Performance Plots^[10]

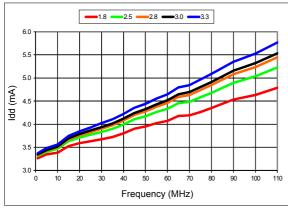


Figure 8. Idd vs Frequency

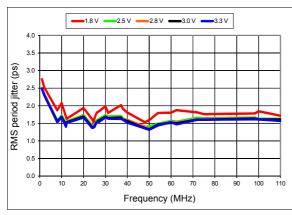


Figure 10. RMS Period Jitter vs Frequency

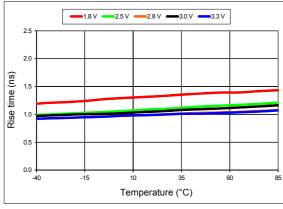


Figure 12. 20%-80% Rise Time vs Temperature

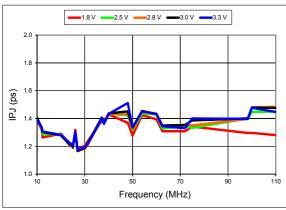


Figure 14. RMS Integrated Phase Jitter Random (12 kHz to 20 MHz) vs Frequency^[11]

Notes:

10. All plots are measured with 15 pF load at room temperature, unless otherwise stated.

Figure 13. 20%-80% Fall Time vs Temperature

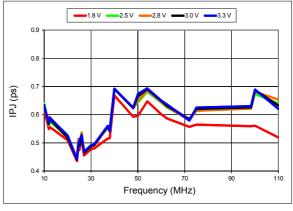


Figure 15. RMS Integrated Phase Jitter Random (900 kHz to 20 MHz) vs Frequency^[11]

11. Phase noise plots are measured with Agilent E5052B signal source analyzer. Integration range is up to 5 MHz for carrier frequencies below 40 MHz. come visit our site http://www.yxc.hk

Temperature (°C) Figure 9. Frequency vs Temperature

20 30 40

DUT1

DUT6

20 15

10

5

0

-5

-10

-15 -20

. 40 -30 -20 -10

Frequency (ppm)

DUT2

DUT7

•

DUT3

DUT8

DUT4

DUT9

DUT5

DUT10

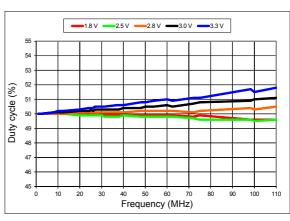
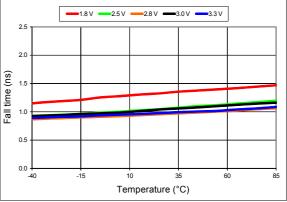


Figure 11. Duty Cycle vs Frequency







Programmable Drive Strength

给您一颗快乐的

The YSO8008MR includes a programmable drive strength feature to provide a simple, flexible tool to optimize the clock rise/fall time for specific applications. Benefits from the programmable drive strength feature are:

"去"

- Improves system radiated electromagnetic interference (EMI) by slowing down the clock rise/fall time
- Improves the downstream clock receiver's (RX) jitter by decreasing (speeding up) the clock rise/fall time.
- Ability to drive large capacitive loads while maintaining full

EMI Reduction by Slowing Rise/Fall Time

Figure 16 shows the harmonic power reduction as the rise/fall times are increased (slowed down). The rise/fall times are expressed as a ratio of the clock period. For the ratio of 0.05, the signal is very close to a square wave. For the ratio of 0.45, the rise/fall times are very close to near-triangular waveform. These results, for example, show that the 11th clock harmonic can be reduced by 35 dB if the rise/fall edge is increased from 5% of the period to 45% of the period.

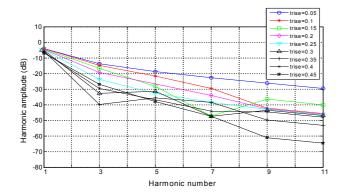


Figure 16. Harmonic EMI reduction as a Function of Slower Rise/Fall Time

Jitter Reduction with Faster Rise/Fall Time

Power supply noise can be a source of jitter for the downstream chipset. One way to reduce this jitter is to speed up the rise/fall time of the input clock. Some chipsets may also require faster rise/fall time in order to reduce their sensitivity to this type of jitter. Refer to the Rise/Fall Time Tables (Table 7 to Table 11) to determine the proper drive strength.

High Output Load Capability

The rise/fall time of the input clock varies as a function of the actual capacitive load the clock drives. At any given drive strength, the rise/fall time becomes slower as the output load increases. As an example, for a 3.3V YSO8008 MR device with default drive strength setting, the typical rise/fall time is 1 ns for 15 pF output load. The typical rise/fall time slows down to 2.6 ns when the output load increases to 45 pF. One can choose to speed up the rise/fall time to 1.83 ns by then increasing the drive strength setting on the YSO8008MR.

The YSO8008MR can support up to 60 pF or higher in maximum capacitive loads with drive strength settings. Refer to the Rise/Tall Time Tables (Table 7 to 11) to determine the proper drive strength for the desired combination of output load vs. rise/fall time.

YSO8008MR Drive Strength Selection

Tables 7 through 11 define the rise/fall time for a given capacitive load and supply voltage.

- 1. Select the table that matches the YSO8008MR nominal supply voltage (1.8V, 2.5V, 2.8V, 3.0V, 3.3V).
- Select the capacitive load column that matches the application requirement (5 pF to 60 pF)
- 3. Under the capacitive load column, select the desired rise/fall times.
- 4. The left-most column represents the part number code for the corresponding drive strength.
- 5. Add the drive strength code to the part number for ordering purposes.

7/9





Rise/Fall Time (20% to 80%) vs $\rm C_{\rm LOAD}$ Tables

YX(

Table 7. Vdd = 1.8V Rise/Fall Times for Specific C_{LOAD}

扬兴晶振

Rise/Fall Time Typ (ns)							
Drive Strength $\ C_{\rm LOAD}$	5 pF	15 pF	30 pF	45 pF	60 pF		
L	6.16	11.61	22.00	31.27	39.91		
Α	3.19	6.35	11.00	16.01	21.52		
R	2.11	4.31	7.65	10.77	14.47		
В	1.65	3.23	5.79	8.18	11.08		
Т	0.93	1.91	3.32	4.66	6.48		
E	0.78	1.66	2.94	4.09	5.74		
U	0.70	1.48	2.64	3.68	5.09		
F or "-": default	0.65	1.30	2.40	3.35	4.56		

Table 8. Vdd = 2.5V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)							
Drive Strength \ C _{LOAD} 5 pF 15 pF 30 pF 45 pF							
L	4.13	8.25	12.82	21.45	27.79		
Α	2.11	4.27	7.64	11.20	14.49		
R	1.45	2.81	5.16	7.65	9.88		
В	1.09	2.20	3.88	5.86	7.57		
Т	0.62	1.28	2.27	3.51	4.45		
E or "-": default	0.54	1.00	2.01	3.10	4.01		
U	0.43	0.96	1.81	2.79	3.65		
F	0.34	0.88	1.64	2.54	3.32		

Table 9. Vdd = 2.8V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)								
Drive Strength \ C _{LOAD}	5 pF	15 pF	30 pF	45 pF	60 pF			
L	3.77	7.54	12.28	19.57	25.27			
А	1.94	3.90	7.03	10.24	13.34			
R	1.29	2.57	4.72	7.01	9.06			
В	0.97	2.00	3.54	5.43	6.93			
Т	0.55	1.12	2.08	3.22	4.08			
E or "-": default	0.44	1.00	1.83	2.82	3.67			
U	0.34	0.88	1.64	2.52	3.30			
F	0.29	0.81	1.48	2.29	2.99			

Rise/Fall Time Typ (ns)							
Drive Strength $\ C_{\text{LOAD}}$	5 pF	15 pF	30 pF	45 pF	60 pF		
L	3.60	7.21	11.97	18.74	24.30		
Α	1.84	3.71	6.72	9.86	12.68		
R	1.22	2.46	4.54	6.76	8.62		
В	0.89	1.92	3.39	5.20	6.64		
T or "-": default	0.51	1.00	1.97	3.07	3.90		
E	0.38	0.92	1.72	2.71	3.51		
U	0.30	0.83	1.55	2.40	3.13		
F	0.27	0.76	1.39	2.16	2.85		

Table 11. Vdd = 3.3V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)								
Drive Strength $\ C_{LOAD}$	5 pF	15 pF	30 pF	45 pF	60 pF			
L	3.39	6.88	11.63	17.56	23.59			
А	1.74	3.50	6.38	8.98	12.19			
R	1.16	2.33	4.29	6.04	8.34			
В	0.81	1.82	3.22	4.52	6.33			
T or "-": default	0.46	1.00	1.86	2.60	3.84			
E	0.33	0.87	1.64	2.30	3.35			
U	0.28	0.79	1.46	2.05	2.93			
F	0.25	0.72	1.31	1.83	2.61			

⊕_{8/9}



Pin 1 Configuration Options (OE, ST, or NC)

Pin 1 of the YSO8008MR can be factory-programmed to support three modes: Output Enable (OE), standby (\overline{ST}) or No Connect (NC).

Output Enable (OE) Mode

In the OE mode, applying logic Low to the OE pin only disables the output driver and puts it in Hi-Z mode. The core of the device continues to operate normally. Power consumption is reduced due to the inactivity of the output. When the OE pin is pulled High, the output is ty pically enabled in <1 μ s.

Standby (ST) Mode

In the \overline{ST} mode, a device enters into the standby mode when Pin 1 pulled Low. All internal circuits of the device are turned off. The current is reduced to a standby current, typically in the range of a few μ A. When \overline{ST} is pulled High, the device goes through the "resume" process, which can take up to 5 ms.

No Connect (NC) Mode

In the NC mode, the device always operates in its normal mode and outputs the specified frequency regardless of the logic level on pin 1.

Table 12 below summarizes the key relevant parameters in the operation of the device in OE, \overline{ST} , or NC mode.

	OE	ST	NC
Active current 20 MHz (max, 1.8V)	4.1 mA	4.1 mA	4.1 mA
OE disable current (max. 1.8V)	4 mA	N/A	N/A
Standby current (typical 1.8V)	N/A	0.6 µA	N/A
OE enable time at 20 MHz (max)	200 ns	N/A	N/A
Resume time from standby (max, all frequency)	N/A	5 ms	N/A
Output driver in OE disable/standby mode	High Z	weak pull-down	N/A

Table 12. OE vs. ST vs. NC

Output on Startup and Resume

The YSO8008MR comes with gated output. Its clock output is accurate to the rated frequency stability within the first pulse from initial device startup or resume from the standby mode.

In addition, the YSO8008MR features "no runt" pulses and "no glitch" output during startup or resume as shown in the waveform captures in Figure 17 and Figure 18.



Figure 17. Startup Waveform vs. Vdd

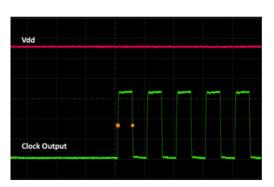


Figure 18. Startup Waveform vs. Vdd (Zoomed-in View of Figure 17)

9/9

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Standard Clock Oscillators category:

Click to view products by Yangxing manufacturer:

Other Similar products are found below :

601252 F335-25 F535L-33.333 F535L-50 ASV-20.000MHZ-LR-T ECS-2018-160-BN-TR MXO45HS-2C-66.6666MHZ SiT1602BI-22-33E-50.00000E SiT8209AI-32-33E-125.00000 SIT8918AA-11-33S-50.00000G SM4420TEV-40.0M-T1K SMA4306-TL-H F335-24 F335-40 F535L-10 F535L-12 F535L-16 F535L-24 F535L-27 F535L-48 PE7744DW-100.0M ASF1-3.686MHZ-N-K-S ASV-4.000MHZ-LCS-T XLH735025.000JU418 XLP725125.000JU618 XO57CTECNA3M6864 ECS-2100A-147.4 601251 EP16E7E2H26.000MTR SiT8503AI-18-33E-0.200000X SIT8918AA-11-33S-16.000000G SIT9122AI2C233E300.000000X XO37CTECNA20M XO3003 9120AC-2D2-33E212.500000 9102AI-243N25E100.00000 8208AC-82-18E-25.00000 ASDK2-32.768KHZ-LR-T3 8008AI-72-XXE-24.545454E 8004AC-13-33E-133.33000X ASFL1-48.000MHZ-LC-T 632L31004M00000 SIT8920AM-31-33E-25.0000 DSC1028DI2-019.2000 9121AC-2C3-25E100.00000 9102AI-233N33E100.00000X 9102AI-233N25E200.00000 9102AI-232H25S125.00000 9102AI-133N25E200.00000 9102AC-283N25E200.00000